

ABSTRACT

A component having an airdome enclosure that protects the component from its external environment. An airdome enclosure according to the present 5 techniques avoids the high costs of employing special materials and/or specialized process steps in the manufacture of a component. An electronic component according to the present techniques includes a set of substructures formed on a substrate and an airdome 10 enclosure over the substructures that protects the substructures and that hinders the formation of parasitic capacitances among the substructures.